

ADVANCED DIRECT IMAGING by ALTIX

HIGH POWER UV LED

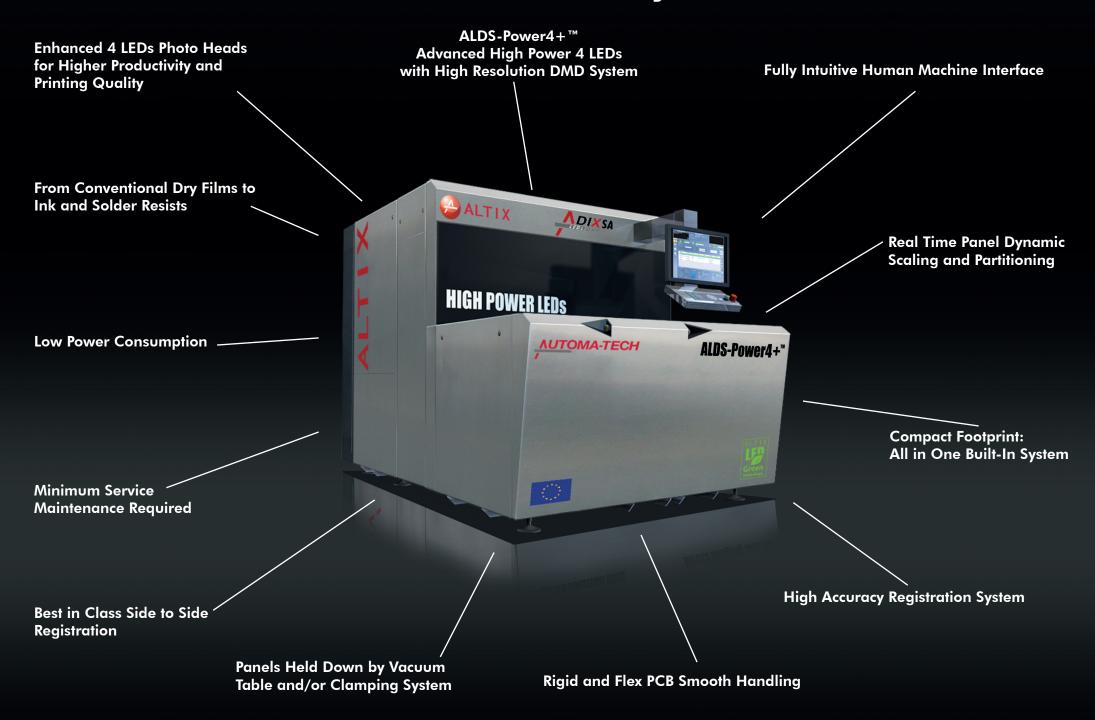


High Resolution DMD



Direct Imaging with us!

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ADIX Specifications

Panel	Panel size Panel thickness Warp and twist Weight	From 228 x 254mm up to 610 x 762mm From 9"x10" up to 24"x30" 0.04 to 6mm 1.6 to 236mils 0.04 to 0.8mm 1.6 to 31mils • panel thickness: 1% of the diagonal 0.8 to 6mm 31 to 236mils • panel thickness: 0.5% of the diagonal 6kg max (13.22lbs)		
lmaging	Resolution - L/S Resolution - DAM Edge Roughness Depth of Focus Autofocus Image to panel registration Side to side registration	10/10µm 0.4/0.4mil ⁽¹⁾ NA ± 0.5µm 100µm ± 8mm ± 315mils ± 8µm ± 0.31mil ± 12µm ± 0.47mil	20/20µm 0.8/0.8mil ⁽¹⁾ 25µm 1mil ± 1.5µm 200µm	50/50μm 2/2mils ⁽¹⁾ 50μm 2mils ± 3μm 400μm
Throughput	Exposure time	14s with 30mJ/cm² resist for 457 x 610mm (18"x 24") image size (6 heads) (2)		
Process	Imaging resist materials Resist sensitivity Exposure spectrum Applications Production types	Conventional dry films or specific for DI • Ink & solder resists From 10 to 1,250mJ/cm² and above 4 wavelengths per Photo Head: 365/380/395/405nm PCB • FPCB / Flex • Photo Chemical Milling • IC Substrate • Touch Panel Inner Layers • Outer Layers • Soldermask (PSR)		
Graphic User Interface	ALTIX Direct Imaging Suite™ Data input	22" touch screen, intuitive software, object oriented, SPC capabilities, multilanguage Extended Gerber, ODB++ (others upon request)		
General utilities & Foot print	Power supply Air supply Water supply Machine weight Dimensions	220/400/480V • 50/60Hz • 4kW 6 bars 1.5m³/min Water pressure 3~5 bars • Flow rate: 23l/min @ 12°C or 33l/min @ 14°C 3,500kg (7,716lbs) L: 2,870mm (113") W: 1,750mm (69") H: 1,870mm (74")		

ADIX Semi-Automatic & Fully-Automatic Direct Imaging Product Range



Adix SA Semi-Automatic Panel to Panel DI Exposure

Semi-Automatic Direct Imaging solution for QTA, high-mix low and medium volume production dedicated for all processes: Inner Layers, Outer Layers and Soldermask (PSR)

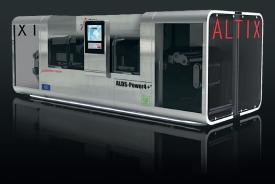


Adix PT / F Pass-Through / Flip In-Line Automation Fully Automatic Double Side

Integrated automation for fully-automatic Direct Imaging process in-line or island of automation.

Pass-through double-sided production with "in the air" flip.

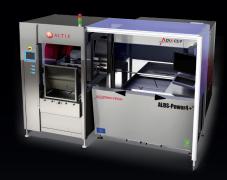
This compact automation is dedicated for all resists: dry film & solder resists and upgradable on site



Adix RtR Roll to Roll DI Exposure Fully-Automatic

ADIX Roll to Roll is a fully automatic Direct Imaging designed as a single sided Roll to Roll exposure system for fine line resolution, tight registration and high throughput capabilities.

It can handle all types of web for Flex Printed Circuit Boards, Photo Chemical Milling, Touch Panel, Thin Film Photovoltaic, etc...



Adix CS / F Compact Standardized / Flip Compact - Island of Automation Fully Automatic Double Side

The system is designed to automatically load and unload panels into an ADIX Direct Imaging system from either angular or slot cassettes.

Anautomaticflip&cleaningfunctions are integrated. The system is able to handle multiple batches and different panel sizes.

This compact automation is dedicated for all resists: dry film & solder resists and upgradable on site



Adix Customized Solutions

ADIX units can be incorporated with various Customized "Smart Automation" solutions in order to match with all specific Customer's needs.

This solution is adequate for small lot sizes, high-mix and high-volume production

ALDS-Power4+™

Advanced high power Leds with high resolution DMD System. The heart of the system is a creative combination of 4 high-density LEDs light sources through a unique optical device coupled to a high frequency (up to 20kHz) DMD coordinated with a graphic signal and projection lens.

This combination enables our ADIX solution to perform high-resolution line and space down to $10\mu m$.

Real time Scaling & Partitioning

Highly accurate real time scaling and distortion compensation technology responds to the PCB material variations. Each digital image can be scaled to match with the panel

distortion.

For each panel, different scale factors can be applied with dynamic imaging modes: linear (Trapezoidal scaling, Orthogonal scaling) and non-linear (Polygonal scaling).

High Accuracy Registration

A multiple CCD cameras vision system enables featuring image to panel registration down to $\pm 8\mu$ m for high-end HDI designs.

Our solution can align the panel via a through hole or various alignment marks.

Our side-to-side registration for inner layers enables high accuracy alignment down to $\pm 12\mu$ m thanks to our exceptional registration system with adjustable points fitting the panel size.

Smart Vacuum & Clamping Technology™

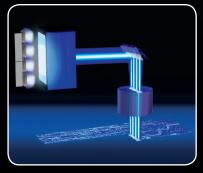
A unique Vacuum & Clamping mechanism offers an automatic selectable vacuum system.

Vacuum and clamping are automatically monitored according to the panel size.

This clamping system can safely hold warped PCBs and handle panel thickness from 40 μ m to 6mm.

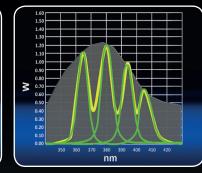
In addition, with the autofocus function, it allows a perfect imaging compared to other systems having only a vacuum table without clamping mechanism.

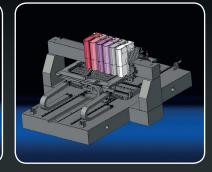
ADIX Advanced Features





Before correction After alignment







High dynamic Autofocus Function

Highly precise and dynamic autofocus system is integrated inside each imaging head. The heads get real time feedbacks in order to take into account the warping and surface thickness variations of the board at ± 8 mm.

This state of the art tool plus the depth of focus of the head, which allows imaging in a consistently suitable state, drastically reduce the occurrence rate of imaging errors.

Multi-wavelengths UV-LED

The combination of different UV light wavelengths enables to polymerize a large range of dry film, ink and solder resists. With 4 LED wavelengths (365/380/395/405nm) and by adjusting the output ratio, it is possible to obtain the most efficient and fast printing for each type of dry resists or soldermask.

UV-LED consumes less energy, generates less heat, and lasts much longer than typical laser diode or blue laser based on light sources.

Number of Light Engines depending on your capacity. Upgradable on Site

Our modular and flexible imaging technology ALDS-Power4™ can be adapted to your throughput requirements. Also, the number of Photo Heads can be chosen accordingly when defining your new Direct Imaging equipment. This number of Photo Heads can be enlarged from 1 to 6 (2 to 6 for RtR) anytime in the future to match with your expanding needs.

This incremental investment enables to have a fully optimized system, which means a quicker Return Of Investment

Human Machine Interface (HMI)

Fully intuitive interface enables a friendly-user utilization for the operators. A state of the art touch screen graphical user interface enables an easy operating such as: quick job setups, parameters monitoring, full diagnosis, or process optimization.

Our powerful software "ALTIX Direct Imaging Suite" offers more with multilingual capabilities and our statistical module "Altix Statistical Process Control Module".

ALTIX, over **30** years of innovations and performances!

eline Product Launch



ColliLight™





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Email: central@altix.fr

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imaging with us!





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